# 2SB0790 (2SB790)

# Silicon PNP epitaxial planar type

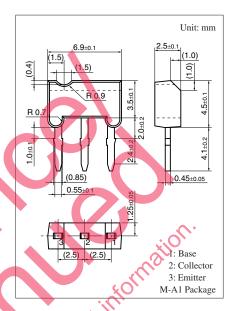
#### For low-frequency output amplification

#### ■ Features

- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-25	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-20	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	-7	V	
Collector current	$I_C$	- 0.5	A	
Peak collector current	$I_{CP}$	-1	A	
Collector power dissipation	P <sub>C</sub>	600	mW	
Junction temperature	T <sub>j</sub>	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	



# ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

Collector power dissipation	$P_{C}$	600 mW	•	10,			
Junction temperature	T <sub>j</sub>	150 °C	S				
Storage temperature	T <sub>stg</sub> -	-55 to +150 °C	XO'	0			
Junction temperature $T_j$ 150 °C  Storage temperature $T_{stg}$ -55 to +150 °C  Electrical Characteristics $T_a = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$							
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■ Electrical Characteristics T <sub>a</sub> = 25°C ± 3°C							
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = -10 \mu\text{A}, I_E = 0$	-25			V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = -1 \text{ mA}, I_R = 0$	-20			V	
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = -10  \mu \text{A}  \text{M}_{\rm C} = 0$	-7			V	
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = -25 \text{ V}, I_E = 0$			- 0.1	μΑ	
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = -20 \text{ V}_{B} = 0$			-1	μΑ	
Forward current transfer ratio *1	h <sub>FE1</sub> *2	$V_{CE} = -2V, I_C = -0.5 A$	90		220	_	
	h <sub>FE2</sub>	$V_{CE} = -2 \text{ V}, I_{C} = -1 \text{ A}$	25			_	
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_C = -500 \text{ mA}, I_B = -50 \text{ mA}$			- 0.4	V	
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_C = -500 \text{ mA}, I_B = -50 \text{ mA}$			-1.2	V	
Transition frequency	$f_T$	$V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz	
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		15	25	pF	
(Common base, input open circuited)							

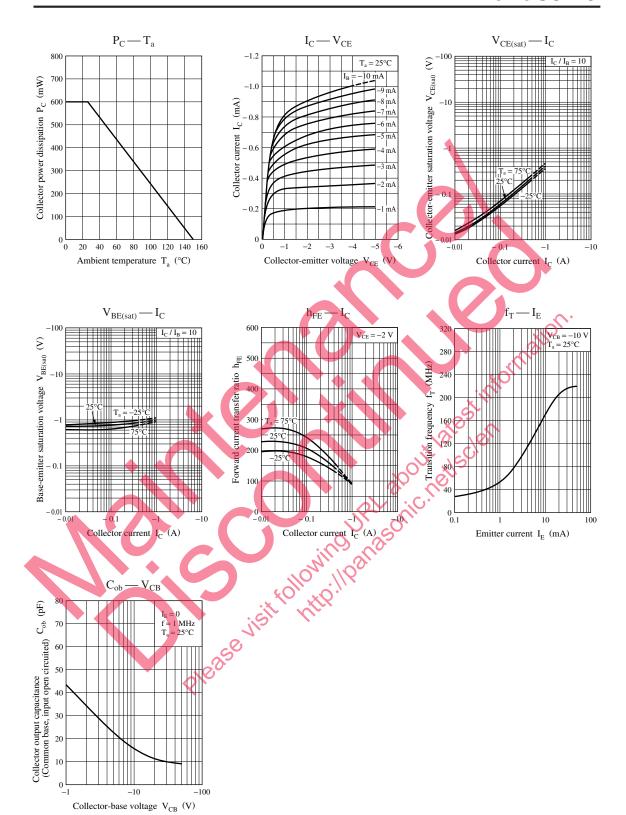
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### 2. \*1: Pulse measurement

#### \*2: Rank classification

Rank	Q	R
$h_{\mathrm{FE1}}$	90 to 155	130 to 220

Note) The part number in the parenthesis shows conventional part number.



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